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JUN 29 2005

Customer No.: 31561  
Application No.: 10/605,163  
Docket No.: 10230-US-PA

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of: )  
WANG, SUNG-FEI ) Examiner: WILLIAMS, ALEXANDER O  
Serial No.: 10/605,163 ) Art Unit: 2826  
Filed: 09/12/2003 ) Docket No.: 10230-US-PA  
For: SEMICONDUCTOR PACKAGE WITH )  
A HEAT SPREADER )

*No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10230-US-PA)*

REQUEST FOR CONTINUED EXAMINATION/ PRELIMINARY AMENDMENT

U.S. Patent and Trademark Office  
Commissioner for Patents  
Customer Service Window Mail Stop RCE  
Randolph Building, 401 Dulany Street  
Alexandria, VA 22314

Sir:

The Advisory Action mailed May 4, 2005 has been carefully considered. In response thereto, Applicant respectfully files a Request for Continued Examination (RCE). Please enter the following amendments and consider the following remarks.

06/29/2005 TL0111 00000025 502620 10605163  
02 FC:1252 450.00 DA

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AMENDMENTS

In the Title:

Please amend the previously presented title of the invention: "MULTI-CHIP MODULE PACKAGE" to "SEMICONDUCTOR PACKAGE WITH A HEAT SPREADER".